# Voltage Regulator – Adjustable Output, Positive

## 500 mA

# LM317M, NCV317MA, NCV317M

The LM317M is an adjustable three−terminal positive voltage regulator capable of supplying in excess of 500 mA over an output voltage range of 1.2 V to 37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow−out proof.

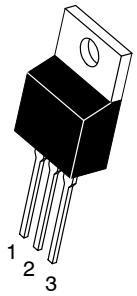
The LM317M serves a wide variety of applications including local, on−card regulation. This device also makes an especially simple adjustable switching regulator, a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM317M can be used as a precision current regulator.

### Features

- Output Current in Excess of 500 mA
- Output Adjustable between 1.2 V and 37 V
- Internal Thermal Overload Protection
- Internal Short Circuit Current Limiting
- Output Transistor Safe−Area Compensation
- Floating Operation for High Voltage Applications
- Eliminates Stocking Many Fixed Voltages
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
- These are Pb−Free Devices

Heatsink surface connected to Pin 2

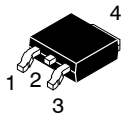
**TO−220AB**
**T SUFFIX**
**CASE 221AB**




**SOT−223**
**ST SUFFIX**
**CASE 318E**




**DPAK**
**DT SUFFIX**
**CASE 369C**




Heatsink Surface (shown as terminal 4 in case outline drawing) is connected to Pin 2.

| PIN ASSIGNMENT | |
|---|---|
| 1 | Adjust |
| 2 | $V_{out}$ |
| 3 | $V_{in}$ |

### ORDERING INFORMATION

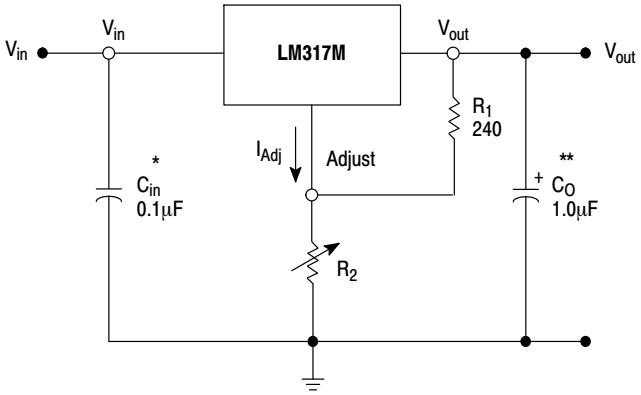
See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 12.

### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 11 of this data sheet.

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* = $C_{in}$ is required if regulator is located an appreciable distance from power supply filter.
** = $C_O$ is not needed for stability, however, it does improve transient response.

$$V_{out} = 1.25\ V\left(1 + \frac{R_2}{R_1}\right) + I_{Adj}\,R_2$$

Since $I_{Adj}$ is controlled to less than 100 μA, the error associated with this term is negligible in most applications.

**Figure 1. Simplified Application**

**MAXIMUM RATINGS** ($T_A$ = 25°C, unless otherwise noted.)

| Symbol | Rating | Value | Unit |
|---|---|---|---|
| $V_I$–$V_O$ | Input–Output Voltage Differential | 40 | Vdc |
| | Power Dissipation (Package Limitation) (Note 1) | | |
| | Plastic Package, T Suffix, Case 221A | | |
| $P_D$ | $T_A$ = 25°C | Internally Limited | |
| $\theta_{JA}$ | Thermal Resistance, Junction–to–Air | 70 | °C/W |
| $\theta_{JC}$ | Thermal Resistance, Junction–to–Case | 5.0 | °C/W |
| | Plastic Package, DT Suffix, Case 369C | | |
| $P_D$ | $T_A$ = 25°C | Internally Limited | |
| $\theta_{JA}$ | Thermal Resistance, Junction–to–Air | 92 | °C/W |
| $\theta_{JC}$ | Thermal Resistance, Junction–to–Case | 5.0 | °C/W |
| | Plastic Package, ST Suffix, Case 318E | | |
| $P_D$ | $T_A$ = 25°C | Internally Limited | |
| $\theta_{JA}$ | Thermal Resistance, Junction–to–Air | 245 | °C/W |
| $\theta_{JC}$ | Thermal Resistance, Junction–to–Case | 15 | °C/W |
| $T_{JMAX}$ | Maximum Junction Temperature | +150 | °C |
| $T_{stg}$ | Storage Temperature Range | −65 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Figure 25 provides thermal resistance versus PC board pad size.



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**ELECTRICAL CHARACTERISTICS** ($V_I - V_O$ = 5.0 V; $I_O$ = 0.1 A, $T_J = T_{low}$ to $T_{high}$ (Note 2), unless otherwise noted.)

| Symbol | Characteristics | Figure | LM317M/LM317MB/NCV317MB Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $Reg_{line}$ | Line Regulation (Note 3) ($T_A$ = 25°C, 3.0 V ≤ $V_I - V_O$ ≤ 40 V) | 3 | – | 0.01 | 0.04 | %/V |
| $Reg_{load}$ | Load Regulation (Note 3)<br>$T_A$ = 25°C, 10 mA ≤ $I_O$ ≤ 0.5 A<br>$V_O$ ≤ 5.0 V<br>$V_O$ ≥ 5.0 V | 4 | <br><br>–<br>– | <br><br>5.0<br>0.1 | <br><br>25<br>0.5 | <br><br>mV<br>% $V_O$ |
| $I_{Adj}$ | Adjustment Pin Current | 5 | – | 50 | 100 | μA |
| $\Delta I_{Adj}$ | Adjustment Pin Current Change<br>2.5 V ≤ $V_I - V_O$ ≤ 40 V, 10 mA ≤ $I_L$ ≤ 0.5 A, $P_D \le P_{max}$ | 3, 4 | – | 0.2 | 5.0 | μA |
| $V_{ref}$ | Reference Voltage<br>3.0 V ≤ $V_I - V_O$ ≤ 40 V, 10 mA ≤ $I_L$ ≤ 0.5 A, $P_D \le P_{max}$ | 5 | 1.20 | 1.25 | 1.30 | V |
| $Reg_{line}$ | Line Regulation 3.0 V ≤ $V_I - V_O$ ≤ 40 V (Note 3) | 3 | – | 0.02 | 0.07 | %/V |
| $Reg_{load}$ | Load Regulation 10 mA ≤ $I_O$ ≤ 0.5 A (Note 3)<br>$V_O$ ≤ 5.0 V<br>$V_O$ ≥ 5.0 V | 4 | <br>–<br>– | <br>20<br>0.3 | <br>70<br>1.5 | <br>mV<br>% $V_O$ |
| $T_S$ | Temperature Stability ($T_{low} \le T_J \le T_{high}$) | 5 | – | 0.7 | – | % $V_O$ |
| $I_{Lmin}$ | Minimum Load Current to Maintain Regulation ($V_I - V_O$ = 40 V) | 5 | – | 3.5 | 10 | mA |
| $I_{max}$ | Maximum Output Current<br>$V_I - V_O$ ≤ 15 V, $P_D \le P_{max}$<br>$V_I - V_O$ = 40 V, $P_D \le P_{max}$, $T_A$ = 25°C | 5 | <br>0.5<br>0.15 | <br>0.9<br>0.25 | <br>–<br>– | A |
| N | RMS Noise, % of $V_O$ ($T_A$ = 25°C, 10 Hz ≤ f ≤ 10 kHz) | – | – | 0.003 | – | % $V_O$ |
| RR | Ripple Rejection, $V_O$ = 10 V, f = 120 Hz (Note 4)<br>Without $C_{Adj}$<br>$C_{Adj}$ = 10 μF | 6 | <br>–<br>66 | <br>65<br>80 | <br>–<br>– | dB |
| – | Thermal Shutdown (Note 5) | – | – | 180 | – | °C |
| S | Long−Term Stability, $T_J = T_{high}$ (Note 6)<br>$T_A$= 25°C for End−point Measurements | 5 | – | 0.3 | 1.0 | %/1.0 kHrs. |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. $T_{low}$ to $T_{high}$ = 0° to +125°C for LM317M  $T_{low}$ to $T_{high}$ = −40° to +125°C for LM317MB, NCV317MB.
3. Load and line regulation are specified at constant junction temperature. Changes in $V_O$ due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
4. $C_{Adj}$, when used, is connected between the adjustment pin and ground.
5. Thermal characteristics are not subject to production test.
6. Since Long−Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot−to−lot.



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**ELECTRICAL CHARACTERISTICS** ($V_I - V_O = 5.0$ V; $I_O = 0.1$ A, $T_J = T_{low}$ to $T_{high}$ (Note 7), unless otherwise noted.)

| Symbol | Characteristics | Figure | LM317MA/LM317MAB/NCV317MAB Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $Reg_{line}$ | Line Regulation (Note 8) ($T_A$ = 25°C, 3.0 V ≤ $V_I - V_O$ ≤ 40 V) | 3 | – | 0.01 | 0.04 | %/V |
| $Reg_{load}$ | Load Regulation (Note 8)<br>$T_A$ = 25°C, 10 mA ≤ $I_O$ ≤ 0.5 A<br>$V_O$ ≤ 5.0 V<br>$V_O$ ≥ 5.0 V | 4 | <br><br>–<br>– | <br><br>5.0<br>0.1 | <br><br>25<br>0.5 | <br><br>mV<br>% $V_O$ |
| $I_{Adj}$ | Adjustment Pin Current | 5 | – | 50 | 100 | μA |
| $\Delta I_{Adj}$ | Adjustment Pin Current Change<br>2.5 V ≤ $V_I - V_O$ ≤ 40 V, 10 mA ≤ $I_L$ ≤ 0.5 A, $P_D \le P_{max}$ | 3, 4 | – | 0.2 | 5.0 | μA |
| $V_{ref}$ | Reference Voltage<br>3.0 V ≤ $V_I - V_O$ ≤ 40 V, 10 mA ≤ $I_L$ ≤ 0.5 A, $P_D \le P_{max}$ | 5 | 1.225 | 1.250 | 1.275 | V |
| $Reg_{line}$ | Line Regulation (Note 8)<br>3.0 V ≤ $V_I - V_O$ ≤ 40 V | 3 | – | 0.02 | 0.07 | %/V |
| $Reg_{load}$ | Load Regulation (Note 8)<br>10 mA ≤ $I_O$ ≤ 0.5 A<br>$V_O$ ≤ 5.0 V<br>$V_O$ ≥ 5.0 V | 4 | <br><br>–<br>– | <br><br>20<br>0.3 | <br><br>70<br>1.5 | <br><br>mV<br>% $V_O$ |
| $T_S$ | Temperature Stability ($T_{low} \le T_J \le T_{high}$) | 5 | – | 0.7 | – | % $V_O$ |
| $I_{Lmin}$ | Minimum Load Current to Maintain Regulation ($V_I - V_O$ = 40 V) | 5 | – | 3.5 | 10 | mA |
| $I_{max}$ | Maximum Output Current<br>$V_I - V_O$ ≤ 15 V, $P_D \le P_{max}$<br>$V_I - V_O$ = 40 V, $P_D \le P_{max}$, $T_A$ = 25°C | 5 | <br>0.5<br>0.15 | <br>0.9<br>0.25 | <br>–<br>– | A |
| N | RMS Noise, % of $V_O$ ($T_A$ = 25°C, 10 Hz ≤ f ≤ 10 kHz) | – | – | – | – | % $V_O$ |
| RR | Ripple Rejection, $V_O$ = 10 V, f = 120 Hz (Note 9)<br>Without $C_{Adj}$<br>$C_{Adj}$ = 10 μF | 6 | <br>–<br>66 | <br>65<br>80 | <br>–<br>– | dB |
| – | Thermal Shutdown (Note 10) | – | – | 180 | – | °C |
| S | Long−Term Stability, $T_J = T_{high}$ (Note 11)<br>$T_A$= 25°C for End−point Measurements | 5 | – | 0.3 | 1.0 | %/1.0 kHrs. |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

7. $T_{low}$ to $T_{high}$ = 0° to +125°C for LM317MA  $T_{low}$ to $T_{high}$ = −40° to +125°C for LM317MAB, NCV317MAB.
8. Load and line regulation are specified at constant junction temperature. Changes in $V_O$ due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
9. $C_{Adj}$, when used, is connected between the adjustment pin and ground.
10. Thermal characteristics are not subject to production test.
11. Since Long−Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot−to−lot.



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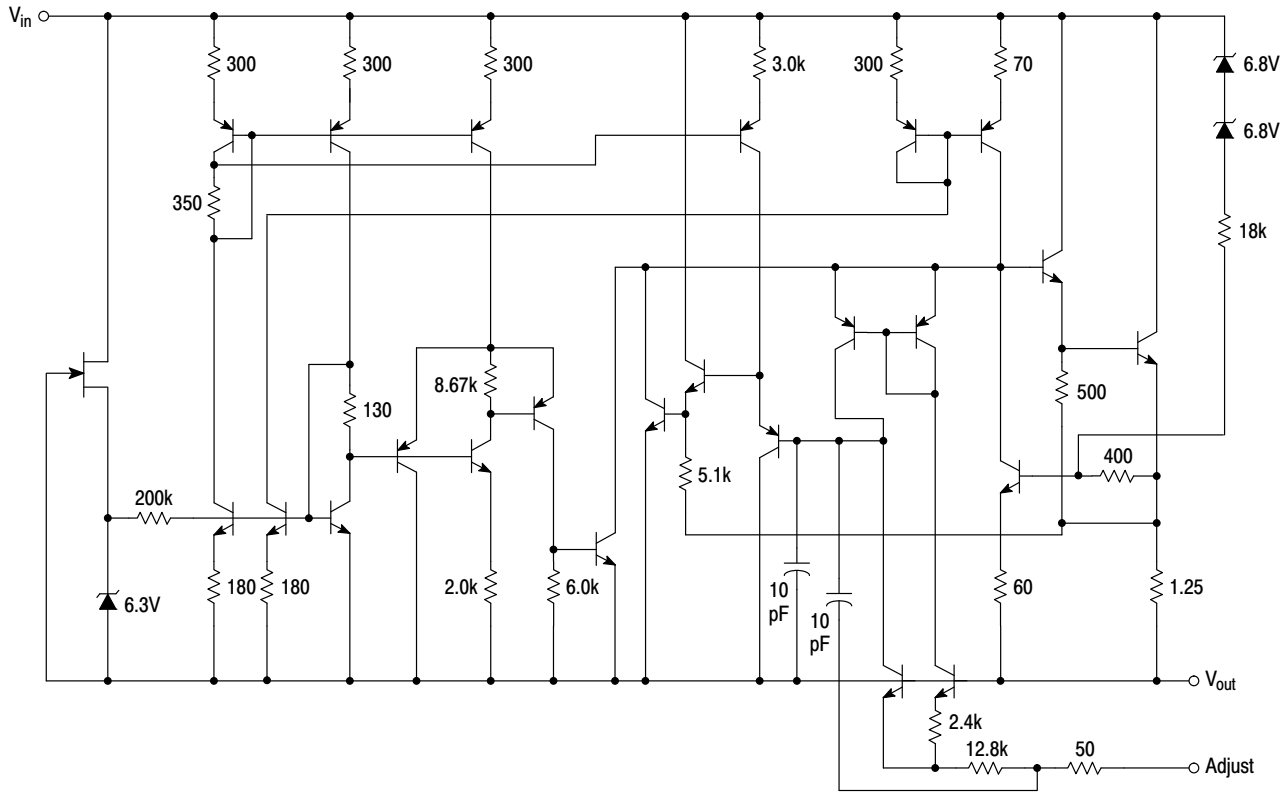



**Figure 2. Representative Schematic Diagram**

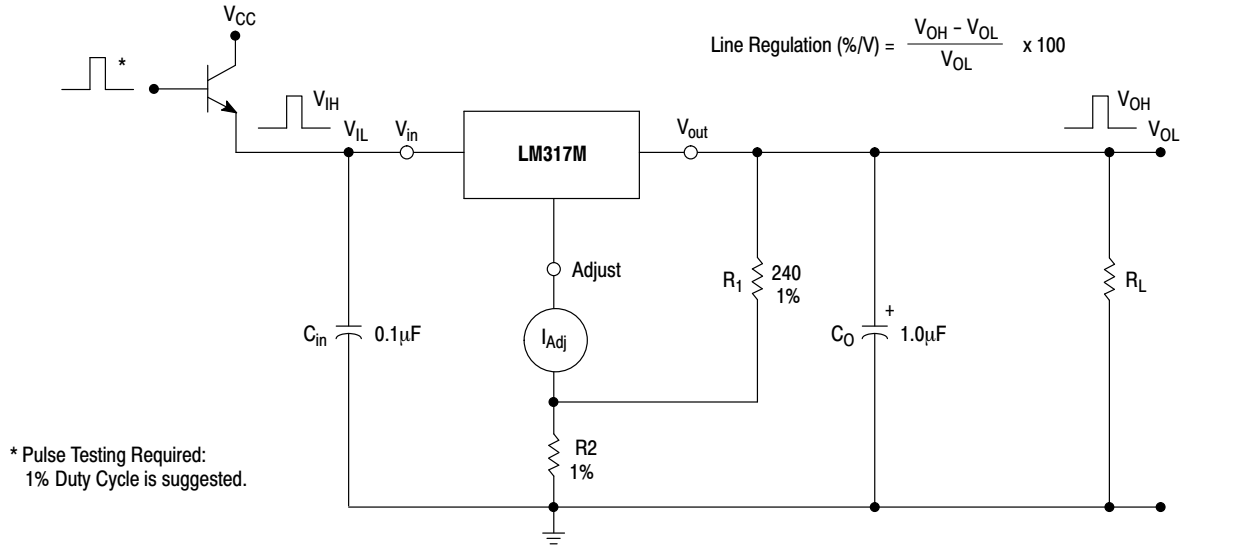



**Figure 3. Line Regulation and $\Delta I_{Adj}$/Line Test Circuit**



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$$\text{Load Regulation (mV)} = V_O \text{ (min Load)} - V_O \text{ (max Load)}$$

$$\text{Load Regulation (\% } V_O) = \frac{V_O \text{ (min Load)} - V_O \text{ (max Load)}}{V_O \text{ (min Load)}} \times 100$$

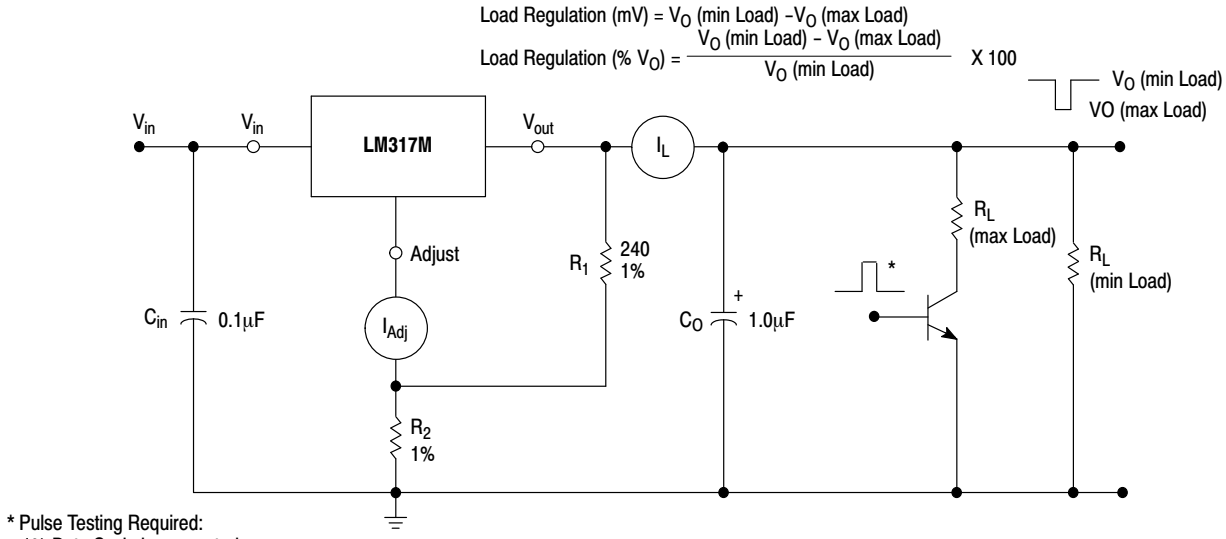



**Figure 4. Load Regulation and $\Delta I_{Adj}$/Load Test Circuit**

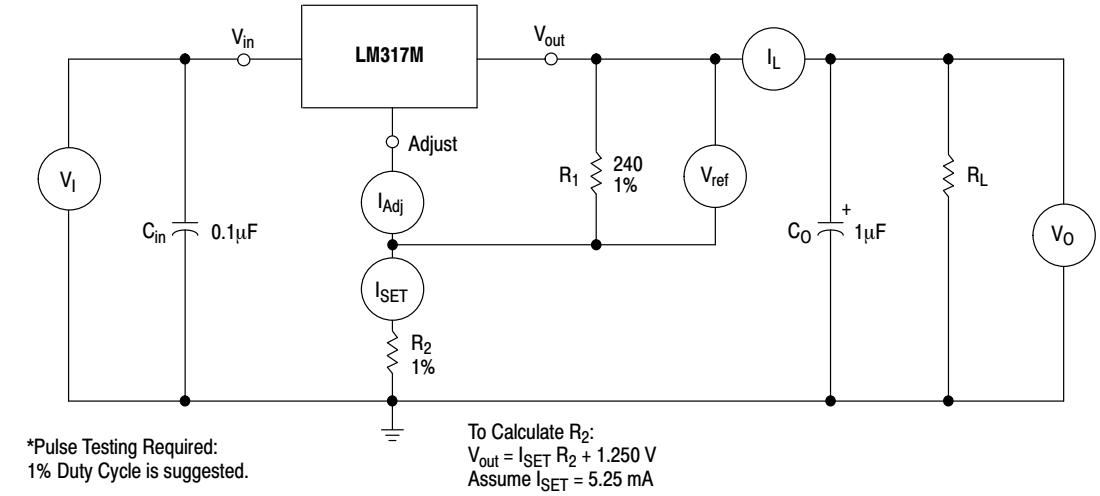



**Figure 5. Standard Test Circuit**

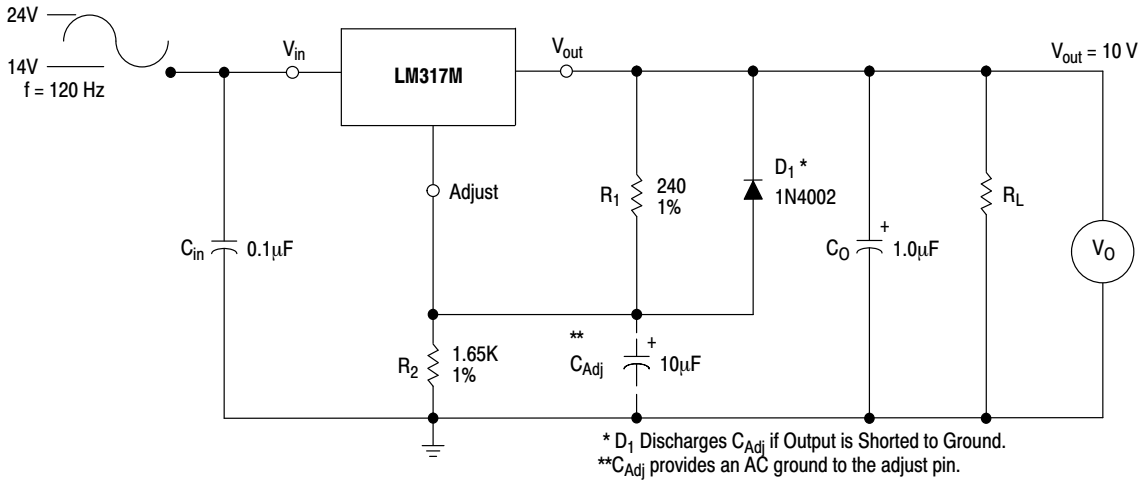



**Figure 6. Ripple Rejection Test Circuit**



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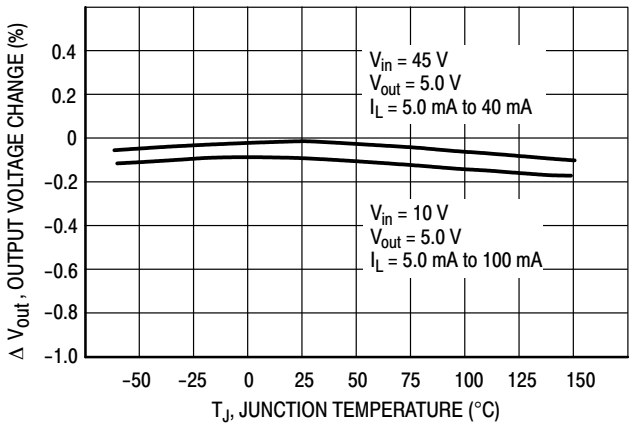



**Figure 7. Load Regulation**

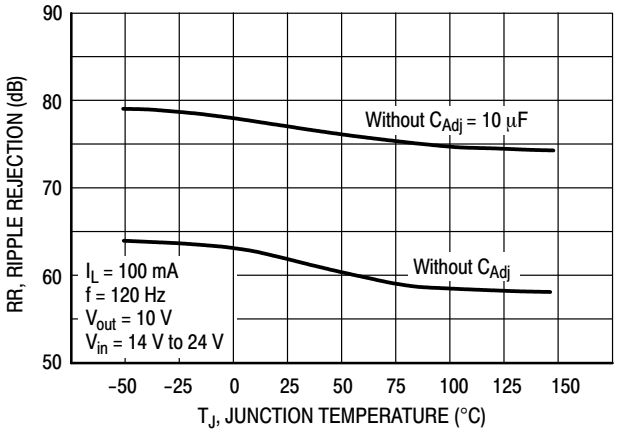



**Figure 8. Ripple Rejection**

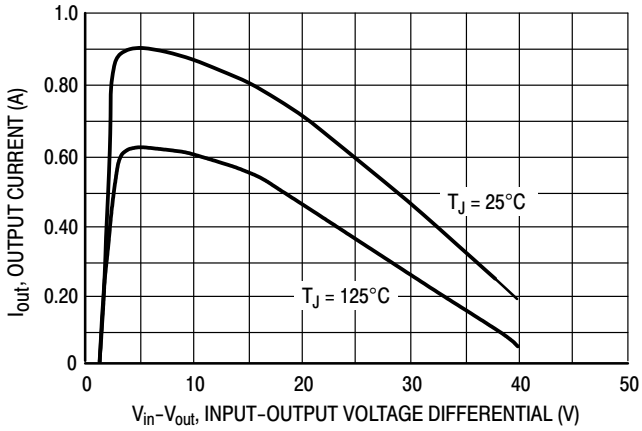



**Figure 9. Current Limit**

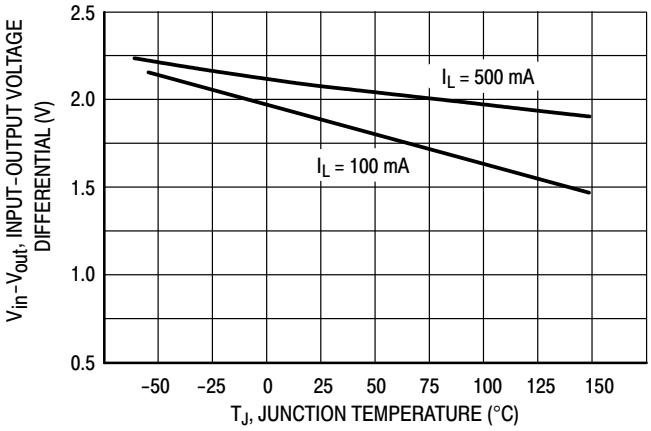



**Figure 10. Dropout Voltage**

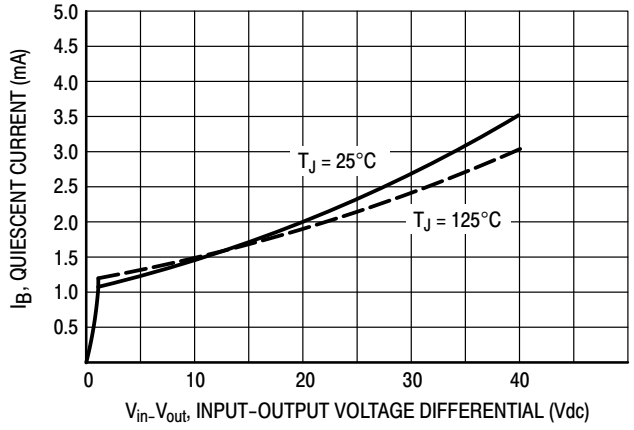



**Figure 11. Minimum Operating Current**

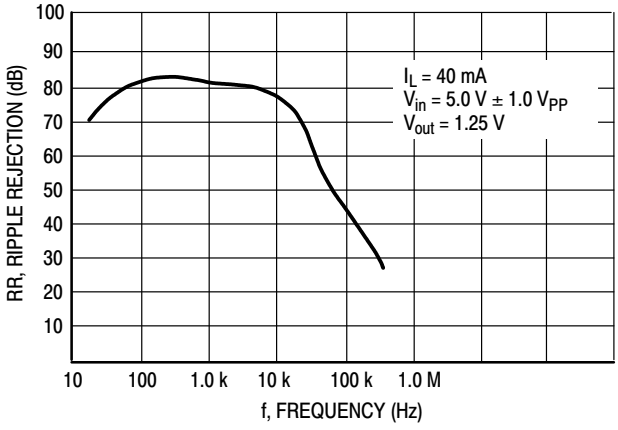



**Figure 12. Ripple Rejection versus Frequency**



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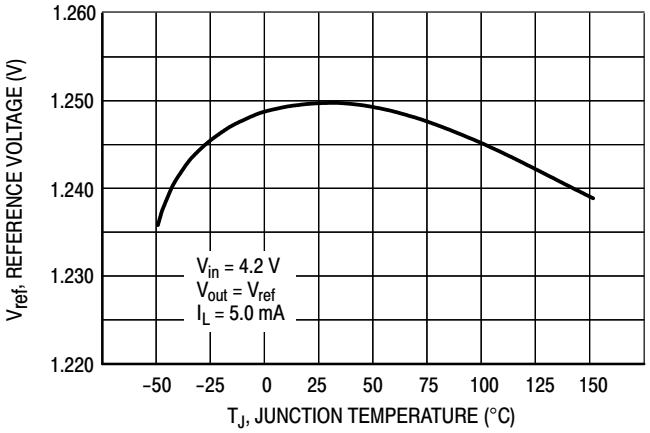



**Figure 13. Temperature Stability**

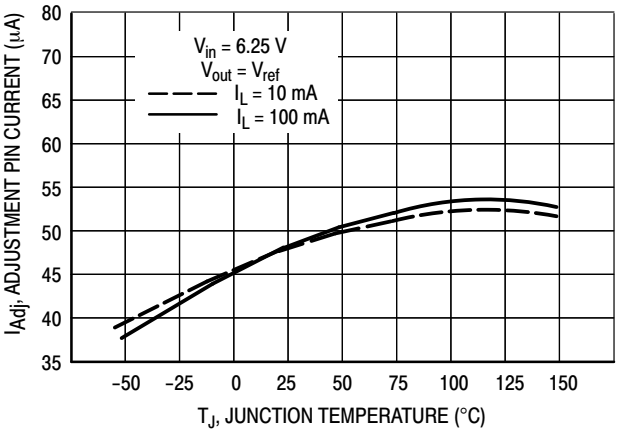



**Figure 14. Adjustment Pin Current**

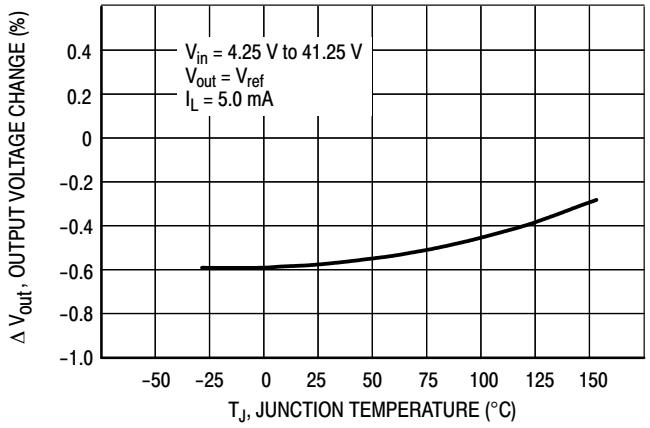



**Figure 15. Line Regulation**

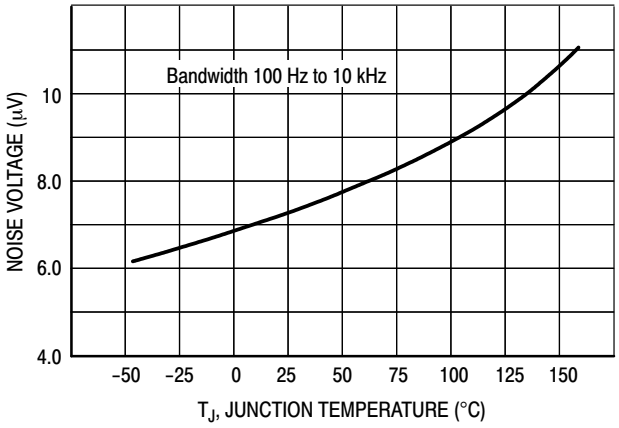



**Figure 16. Output Noise**

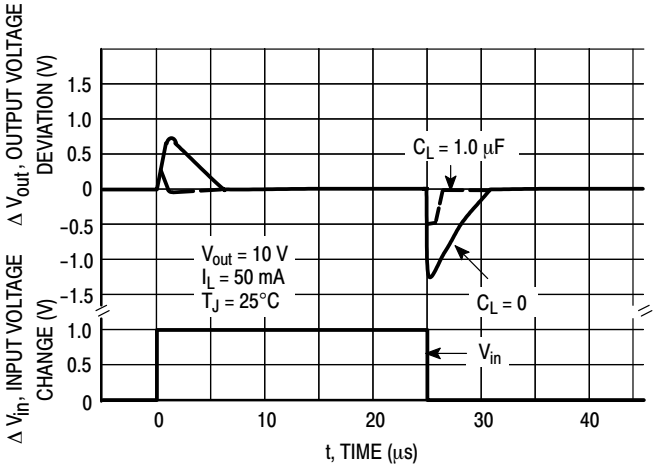



**Figure 17. Line Transient Response**

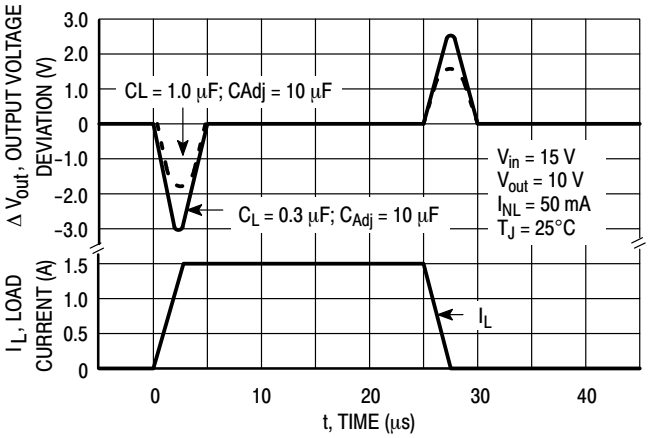



**Figure 18. Load Transient Response**



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## APPLICATIONS INFORMATION

### Basic Circuit Operation

The LM317M is a three−terminal floating regulator. In operation, the LM317M develops and maintains a nominal 1.25 V reference ($V_{ref}$) between its output and adjustment terminals. This reference voltage is converted to a programming current ($I_{PROG}$) by $R_1$ (see Figure 19), and this constant current flows through $R_2$ to ground. The regulated output voltage is given by:

$$V_{out} = V_{ref}\left(1 + \frac{R_2}{R_1}\right) + I_{Adj}R_2$$

Since the current from the terminal ($I_{Adj}$) represents an error term in the equation, the LM317M was designed to control $I_{Adj}$ to less than 100 μA and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM317M is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

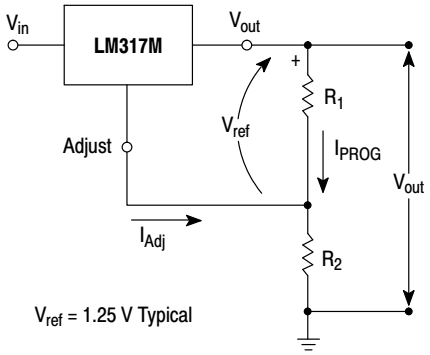



**Figure 19. Basic Circuit Configuration**

### Load Regulation

The LM317M is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor ($R_1$) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of $R_2$ can be returned near the load ground to provide remote ground sensing and improve load regulation.

### External Capacitors

A 0.1 μF disc or 1.0 μF tantalum input bypass capacitor ($C_{in}$) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor ($C_{Adj}$) prevents ripple from being amplified as the output voltage is increased. A 10 μF capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10 V application.

Although the LM317M is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance ($C_O$) in the form of a 1.0 μF tantalum or 25 μF aluminum electrolytic capacitor on the output swamps this effect and insures stability.

### Protection Diodes

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 20 shows the LM317M with the recommended protection diodes for output voltages in excess of 25 V or high capacitance values ($C_O$ > 25 μF, $C_{Adj}$ > 5.0 μF). Diode $D_1$ prevents $C_O$ from discharging thru the IC during an input short circuit. Diode $D_2$ protects against capacitor $C_{Adj}$ discharging through the IC during an output short circuit. The combination of diodes $D_1$ and $D_2$ prevents $C_{Adj}$ from discharging through the IC during an input short circuit.

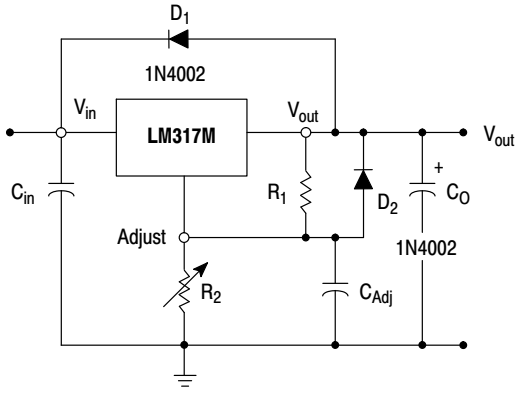



**Figure 20. Voltage Regulator with Protection Diodes**



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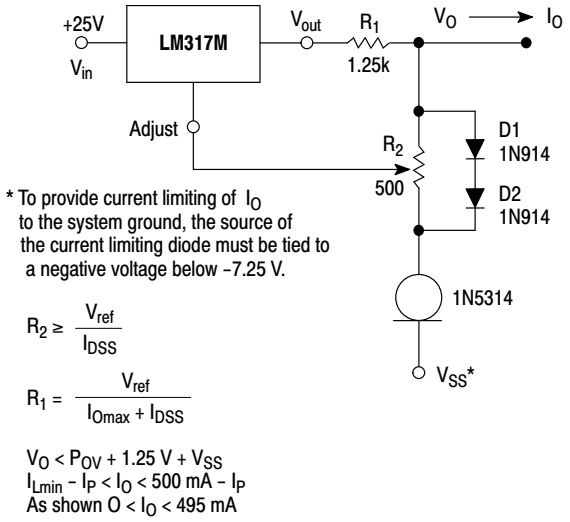



**Figure 21. Adjustable Current Limiter**

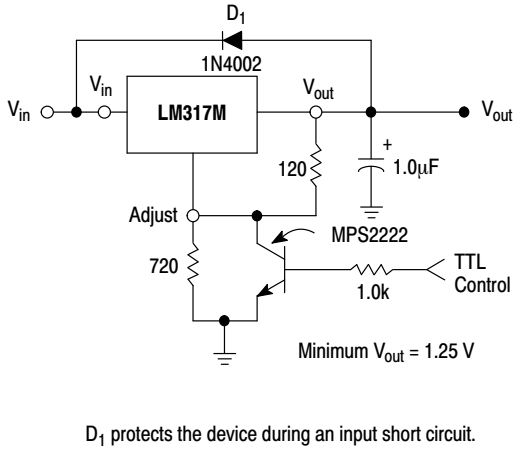



**Figure 22. 5 V Electronic Shutdown Regulator**

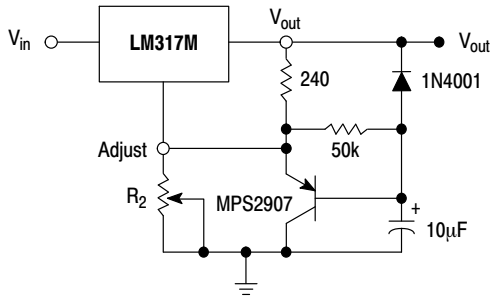



**Figure 23. Slow Turn−On Regulator**

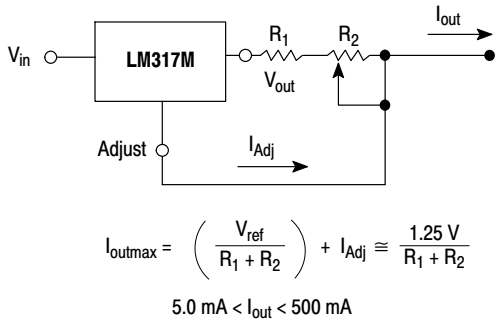



**Figure 24. Current Regulator**

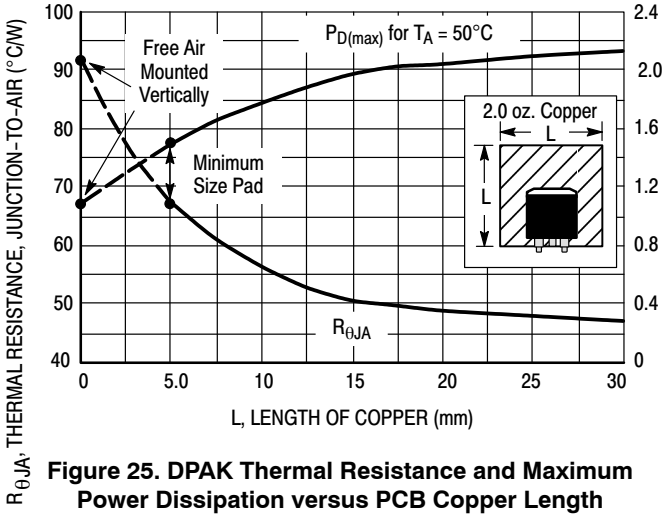



**Figure 25. DPAK Thermal Resistance and Maximum Power Dissipation versus PCB Copper Length**

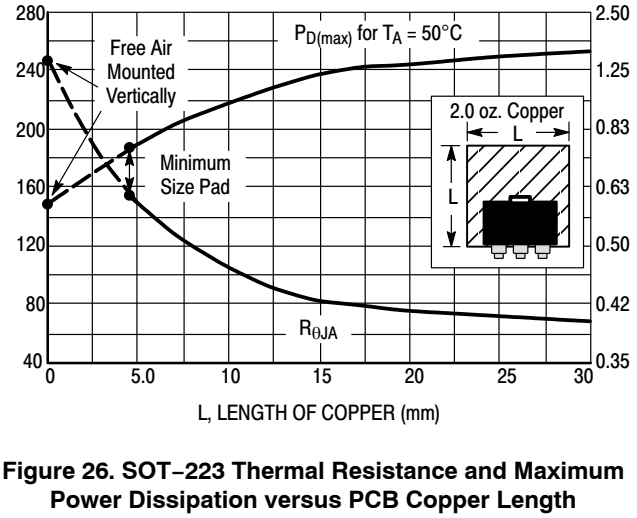


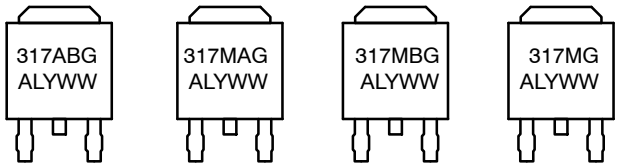

**Figure 26. SOT−223 Thermal Resistance and Maximum Power Dissipation versus PCB Copper Length**



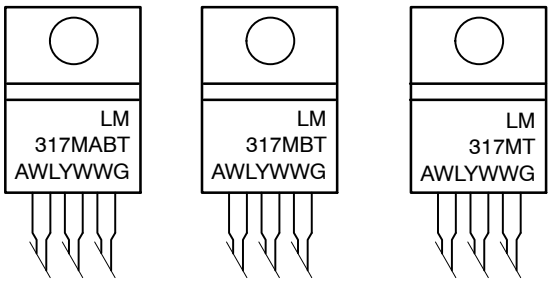
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Your Opinion Matters

## MARKING DIAGRAMS

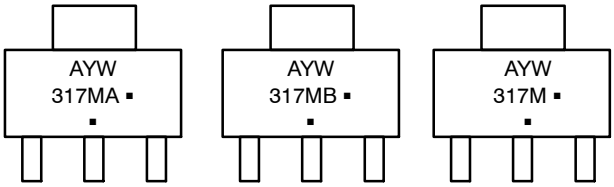
**DPAK**
**DT SUFFIX**
**CASE 369C**




**TO−220**
**T SUFFIX**
**CASE 221A**




**SOT−223**
**ST SUFFIX**
**CASE 318E**




| | |
|---|---|
| A | = Assembly Location |
| L, WL | = Wafer Lot |
| Y | = Year |
| WW, W | = Work Week |
| G or ▪ | = Pb−Free Package |

(Note: Microdot may be in either location)



Share Feedback
Your Opinion Matters

## ORDERING INFORMATION

| Device | Output Voltage Tolerance | Operating Temperature Range | Package | Shipping† |
|---|---|---|---|---|
| LM317MABDTG | 2% | $T_J$ = −40°C to 125°C | DPAK (Pb−Free) | 75 Units / Rail |
| LM317MABDTRKG | | | DPAK (Pb−Free) | 2500 / Tape & Reel |
| NCV317MABDTRKG* | | | | |
| NCV317MABSTT3G* | | | SOT−223 (Pb−Free) | 4000 / Tape & Reel |
| LM317MABTG | | | TO−220 (Pb−Free) | 50 Units / Rail |
| LM317MADTRKG | | $T_J$ = 0°C to 125°C | DPAK (Pb−Free) | 2500 / Tape & Reel |
| LM317MBDTG | 4% | $T_J$ = −40°C to 125°C | DPAK (Pb−Free) | 75 Units / Rail |
| LM317MBDTRKG | | | DPAK (Pb−Free) | 2500 / Tape & Reel |
| NCV317MBDTRKG* | | | | |
| LM317MBSTT3G | | | SOT−223 (Pb−Free) | 4000 / Tape & Reel |
| NCV317MBSTT3G* | | | | |
| LM317MBTG | | | TO−220 (Pb−Free) | 50 Units / Rail |
| LM317MDTG | | $T_J$ = 0°C to 125°C | DPAK (Pb−Free) | 75 Units / Rail |
| LM317MDTRKG | | | DPAK (Pb−Free) | 2500 / Tape & Reel |
| LM317MSTT3G | | | SOT−223 (Pb−Free) | 4000 / Tape & Reel |
| LM317MTG | | | TO−220 (Pb−Free) | 50 Units / Rail |

**DISCONTINUED** (Note 12)

| | | | | |
|---|---|---|---|---|
| NCV317MBDTG* | 4% | $T_J$ = −40°C to 125°C | DPAK (Pb−Free) | 75 Units / Rail |
| NCV317MBTG* | 4% | $T_J$ = −40°C to 125°C | TO−220 (Pb−Free) | 50 Units / Rail |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

12. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

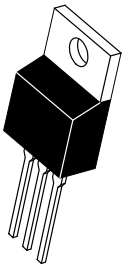
*NCV devices: $T_{low}$ = −40°C, $T_{high}$ = +125°C. Guaranteed by design. NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable.



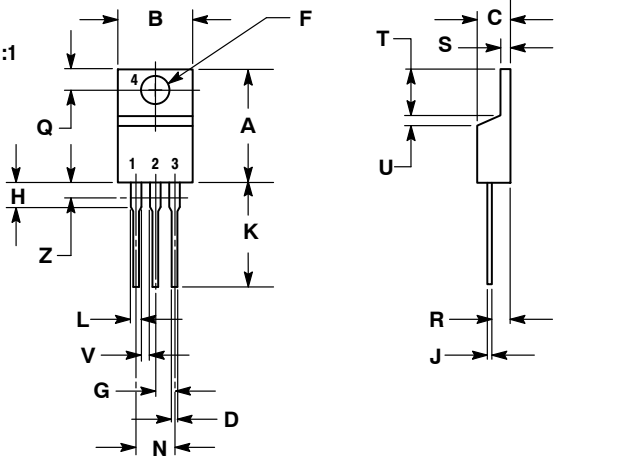
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Your Opinion Matters

## TO−220, SINGLE GAUGE
CASE 221AB
ISSUE A

DATE 16 NOV 2010



SCALE 1:1




NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.
4. PRODUCT SHIPPED PRIOR TO 2008 HAD DIMENSIONS S = 0.045 – 0.055 INCHES (1.143 – 1.397 MM)

| | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| DIM | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.405 | 9.66 | 10.28 |
| C | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.020 | 0.024 | 0.508 | 0.61 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. BASE
2. EMITTER
3. COLLECTOR
4. EMITTER

STYLE 3:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 4:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2

STYLE 5:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 6:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

STYLE 7:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE

STYLE 8:
PIN 1. CATHODE
2. ANODE
3. EXTERNAL TRIP/DELAY
4. ANODE

STYLE 9:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 10:
PIN 1. GATE
2. SOURCE
3. DRAIN
4. SOURCE

STYLE 11:
PIN 1. DRAIN
2. SOURCE
3. GATE
4. SOURCE



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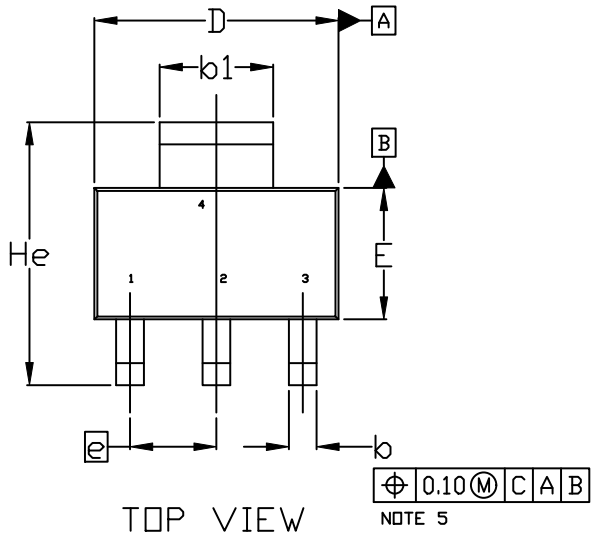
© Semiconductor Components Industries, LLC, 2006

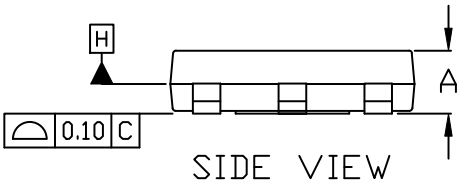


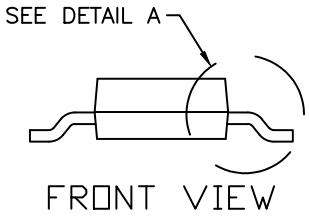
**SCALE 1:1**

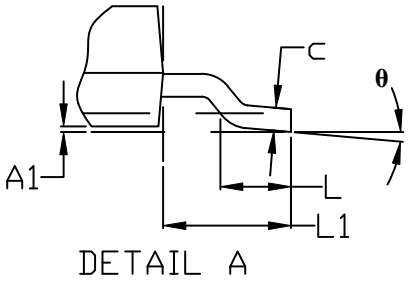
**SOT−223 (TO−261)**
CASE 318E−04
ISSUE R

DATE 02 OCT 2018



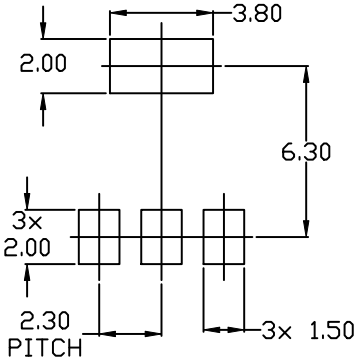




NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.200MM PER SIDE.
4. DATUMS A AND B ARE DETERMINED AT DATUM H.
5. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
6. POSITIONAL TOLERANCE APPLIES TO DIMENSIONS b AND b1.

| | MILLIMETERS | | |
|---|---|---|---|
| DIM | MIN. | NOM. | MAX. |
| A | 1.50 | 1.63 | 1.75 |
| A1 | 0.02 | 0.06 | 0.10 |
| b | 0.60 | 0.75 | 0.89 |
| b1 | 2.90 | 3.06 | 3.20 |
| c | 0.24 | 0.29 | 0.35 |
| D | 6.30 | 6.50 | 6.70 |
| E | 3.30 | 3.50 | 3.70 |
| e | 2.30 BSC | | |
| L | 0.20 | --- | --- |
| L1 | 1.50 | 1.75 | 2.00 |
| He | 6.70 | 7.00 | 7.30 |
| θ | 0° | --- | 10° |




RECOMMENDED MOUNTING FOOTPRINT



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**SOT−223 (TO−261)**
CASE 318E−04
ISSUE R

DATE 02 OCT 2018

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. CATHODE
3. NC
4. CATHODE

STYLE 3:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 4:
PIN 1. SOURCE
2. DRAIN
3. GATE
4. DRAIN

STYLE 5:
PIN 1. DRAIN
2. GATE
3. SOURCE
4. GATE

STYLE 6:
PIN 1. RETURN
2. INPUT
3. OUTPUT
4. INPUT

STYLE 7:
PIN 1. ANODE 1
2. CATHODE
3. ANODE 2
4. CATHODE

STYLE 8:
CANCELLED

STYLE 9:
PIN 1. INPUT
2. GROUND
3. LOGIC
4. GROUND

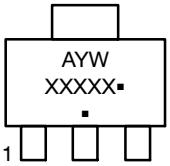
STYLE 10:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 11:
PIN 1. MT 1
2. MT 2
3. GATE
4. MT 2

STYLE 12:
PIN 1. INPUT
2. OUTPUT
3. NC
4. OUTPUT

STYLE 13:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

## GENERIC MARKING DIAGRAM*




A = Assembly Location
Y = Year
W = Work Week
XXXXX = Specific Device Code
▪ = Pb−Free Package

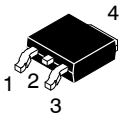
(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.




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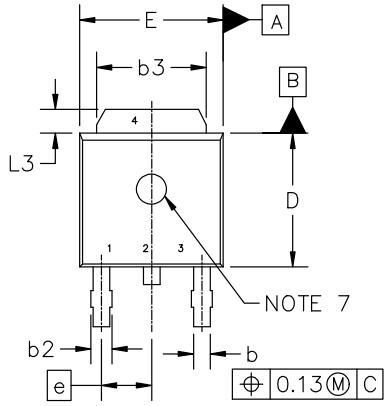
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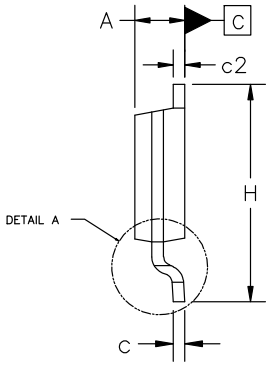

**SCALE 1:1**

**DPAK−3 6.10x6.54x2.28, 2.29P**
CASE 369C
ISSUE L

DATE 24 AUG 2026

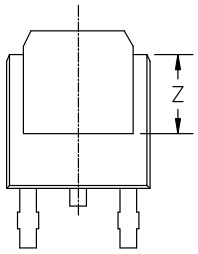



TOP VIEW

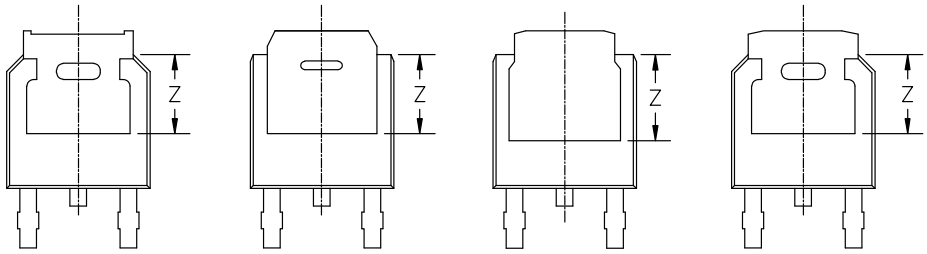



SIDE VIEW

| MILLIMETERS | | | |
|---|---|---|---|
| DIM | MIN | NOM | MAX |
| A | 2.18 | 2.28 | 2.38 |
| A1 | 0.00 | −−− | 0.13 |
| b | 0.63 | 0.76 | 0.89 |
| b2 | 0.72 | 0.93 | 1.14 |
| b3 | 4.57 | 5.02 | 5.46 |
| c | 0.46 | 0.54 | 0.61 |
| c2 | 0.46 | 0.54 | 0.61 |
| D | 5.97 | 6.10 | 6.22 |
| E | 6.35 | 6.54 | 6.73 |
| e | 2.29 BSC | | |
| H | 9.40 | 9.91 | 10.41 |
| L | 1.40 | 1.59 | 1.78 |
| L1 | 2.90 REF | | |
| L2 | 0.51 BSC | | |
| L3 | 0.89 | −−− | 1.27 |
| L4 | −−− | −−− | 1.01 |
| Z | 3.93 | −−− | −−− |



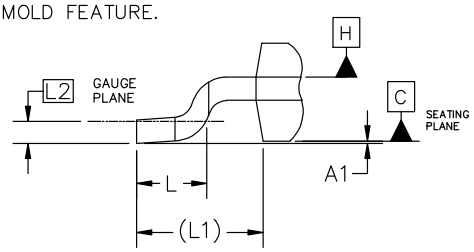

BOTTOM VIEW



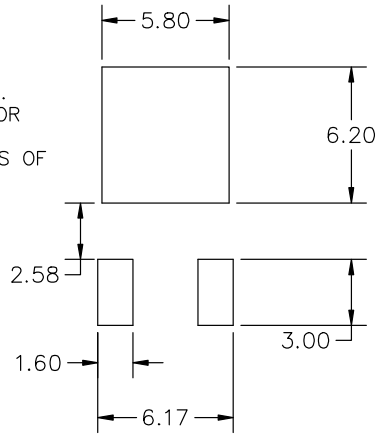

ALTERNATE CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3, AND Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.
7. OPTIONAL MOLD FEATURE.




DETAIL A
ROTATED 90° CW




RECOMMENDED MOUNTING FOOTPRINT*
*For additional information on our Pb−Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques reference manual, SOLDERRM/D.

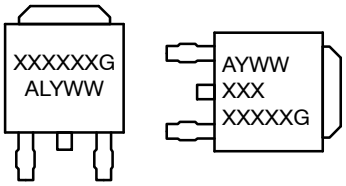
| | | |
|---|---|---|
| **DOCUMENT NUMBER:** | **98AON10527D** | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| **DESCRIPTION:** | **DPAK−3 6.10x6.54x2.28, 2.29P** | **PAGE 1 OF 2** |

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**DPAK−3 6.10x6.54x2.28, 2.29P**
CASE 369C
ISSUE L

DATE 24 AUG 2026

## GENERIC MARKING DIAGRAM*




**IC** **Discrete**

| | |
|---|---|
| XXXXXX | = Device Code |
| A | = Assembly Location |
| L | = Wafer Lot |
| Y | = Year |
| WW | = Work Week |
| G | = Pb−Free Package |

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

STYLE 4:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 5:
PIN 1. GATE
2. ANODE
3. CATHODE
4. ANODE

STYLE 6:
PIN 1. MT1
2. MT2
3. GATE
4. MT2

STYLE 7:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 8:
PIN 1. N/C
2. CATHODE
3. ANODE
4. CATHODE

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. RESISTOR ADJUST
4. CATHODE

STYLE 10:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE




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